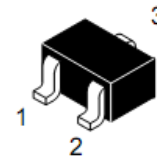
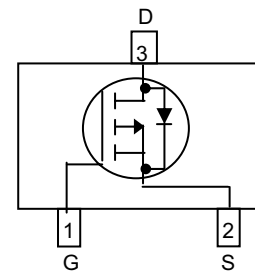
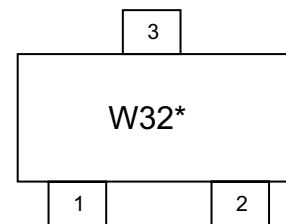


**WPM3012**
**Single P-Channel, -30V, -3.1A, Power MOSFET**
[Http://www.sh-willsemi.com](http://www.sh-willsemi.com)

$V_{DS}$ (V)	$R_{ds(on)}$ ( $\Omega$ )
-30	0.058@ $V_{GS}=-10V$
	0.080@ $V_{GS}=-4.5V$


**SOT-23**

**Pin configuration (Top view)**


W32= Device Code  
\* = Month (A~Z)

**Marking**
**Descriptions**

The WPM3012 is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product WPM3012 is Pb-free and Halogen-free.

**Features**

- Trench Technology
- Supper high density cell design
- Excellent ON resistance for higher DC current
- Extremely Low Threshold Voltage
- Small package SOT-23

**Applications**

- Driver for Relay, Solenoid, Motor, LED etc.
- DC-DC converter circuit
- Power Switch
- Load Switch
- Charging

**Order information**

Device	Package	Shipping
WPM3012-3/TR	SOT-23	3000/Reel&Tape

**Absolute Maximum ratings**

Parameter		Symbol	10 S	Steady State	Unit
Drain-Source Voltage		$V_{DS}$	-30		V
Gate-Source Voltage		$V_{GS}$	$\pm 20$		
Continuous Drain Current <sup>a</sup>	$T_A=25^\circ\text{C}$	$I_D$	-3.1	-2.9	A
	$T_A=70^\circ\text{C}$		-2.5	-2.3	
Maximum Power Dissipation <sup>a</sup>	$T_A=25^\circ\text{C}$	$P_D$	0.9	0.8	W
	$T_A=70^\circ\text{C}$		0.6	0.5	
Continuous Drain Current <sup>b</sup>	$T_A=25^\circ\text{C}$	$I_D$	-2.8	-2.6	A
	$T_A=70^\circ\text{C}$		-2.2	-2.1	
Maximum Power Dissipation <sup>b</sup>	$T_A=25^\circ\text{C}$	$P_D$	0.7	0.6	W
	$T_A=70^\circ\text{C}$		0.5	0.4	
Pulsed Drain Current <sup>c</sup>		$I_{DM}$	-15		A
Operating Junction Temperature		$T_J$	150		$^\circ\text{C}$
Lead Temperature		$T_L$	260		$^\circ\text{C}$
Storage Temperature Range		$T_{stg}$	-55 to 150		$^\circ\text{C}$

**Thermal resistance ratings**

Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance <sup>a</sup>	$t \leq 10 \text{ s}$	$R_{\theta JA}$	105	130	$^\circ\text{C/W}$
	Steady State		120	155	
Junction-to-Ambient Thermal Resistance <sup>b</sup>	$t \leq 10 \text{ s}$	$R_{\theta JA}$	130	160	
	Steady State		145	190	
Junction-to-Case Thermal Resistance		$R_{\theta JC}$	60	75	

a Surface mounted on FR-4 Board using 1 square inch pad size, 1oz copper

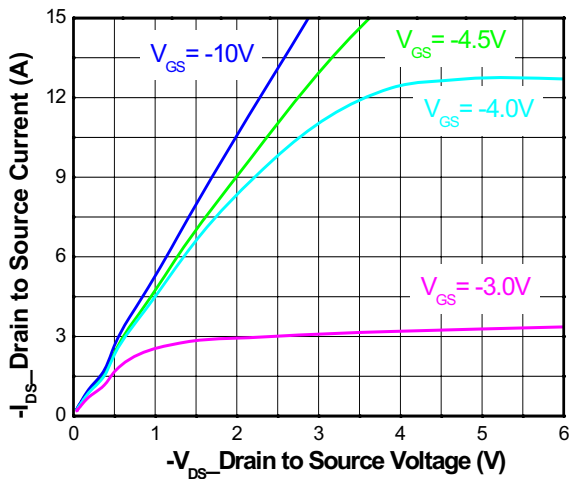
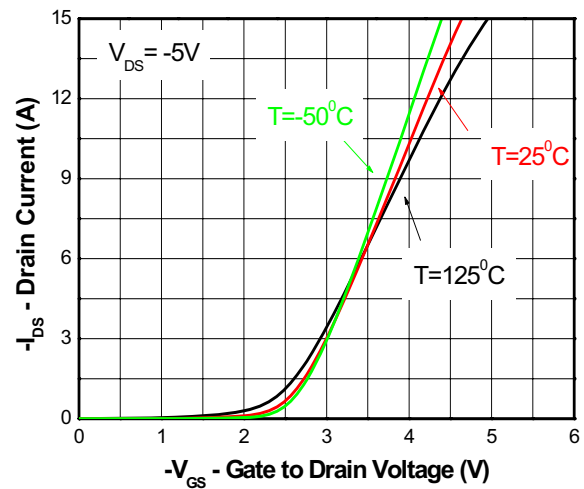
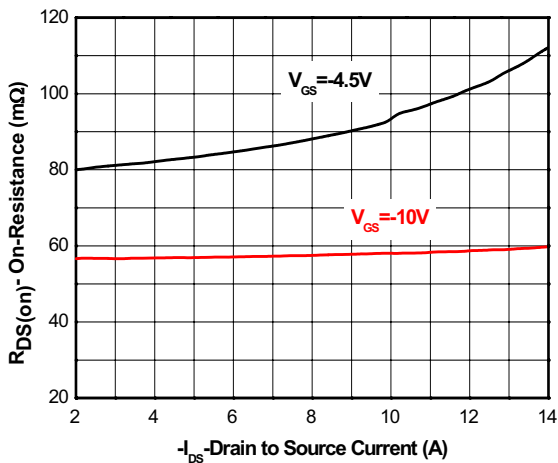
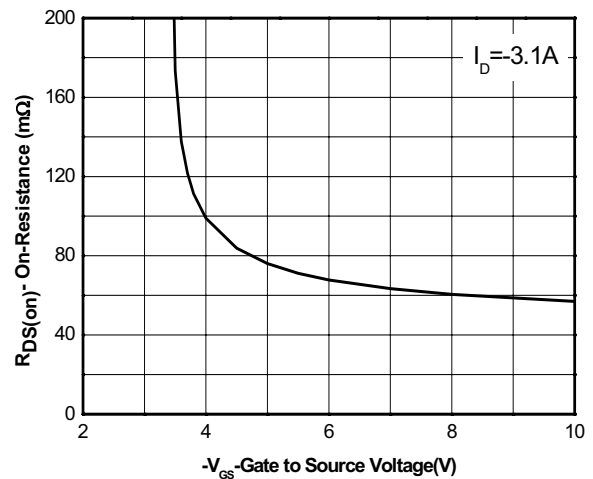
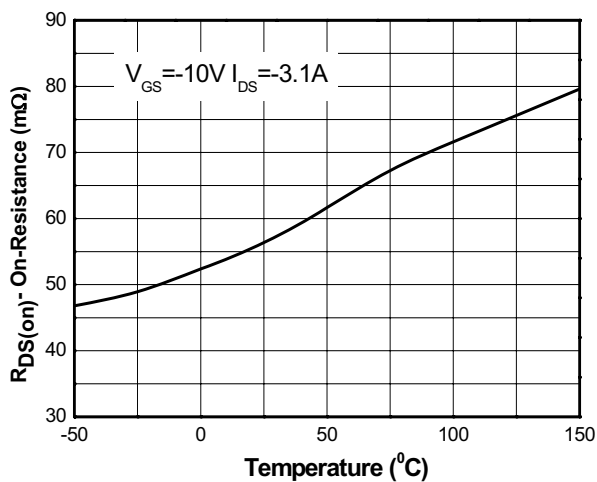
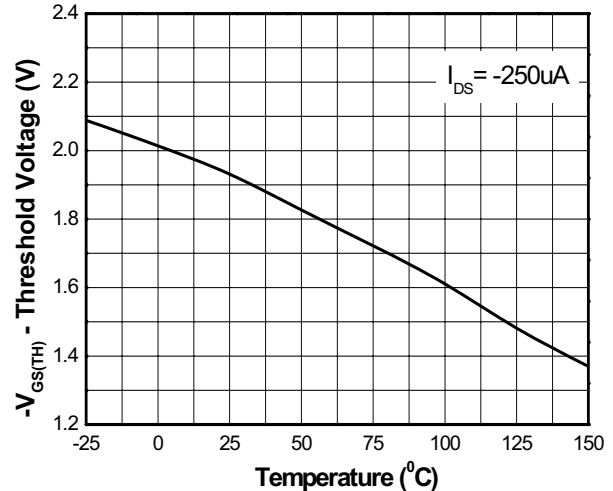
b Surface mounted on FR-4 board using minimum pad size, 1oz copper

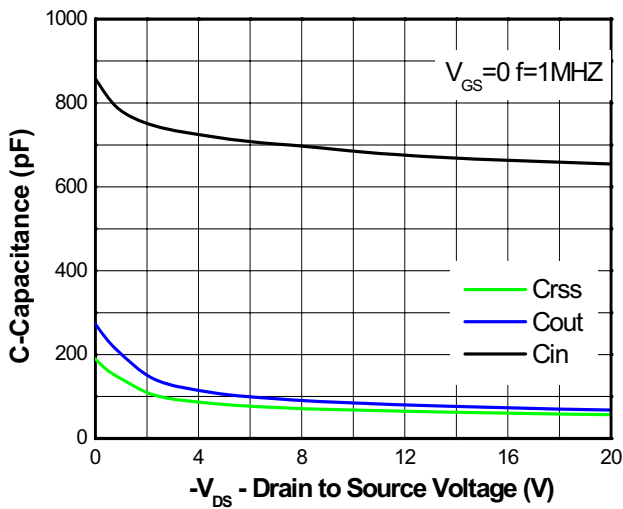
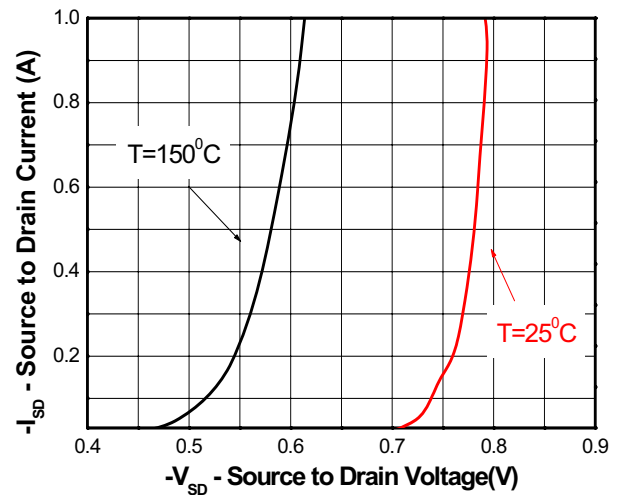
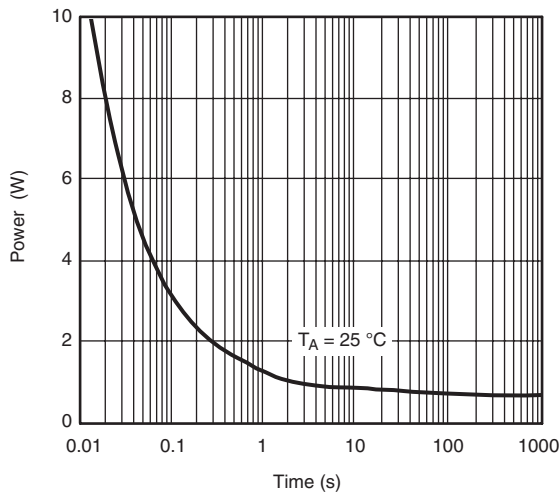
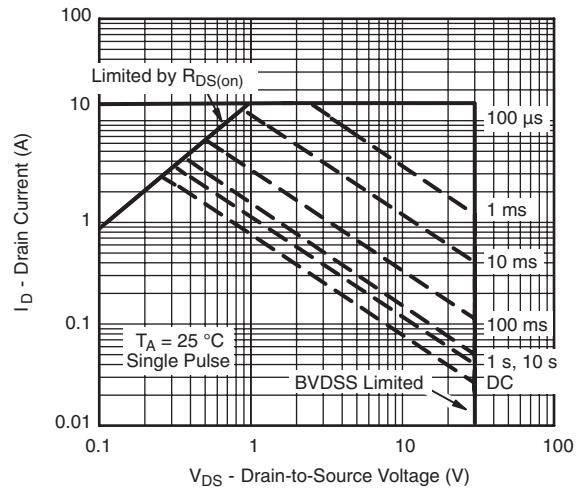
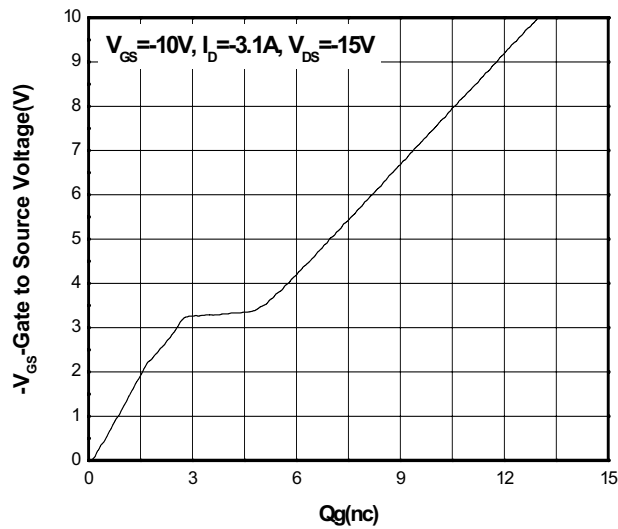
c Pulse width < 380 $\mu\text{s}$ , Duty Cycle < 2%

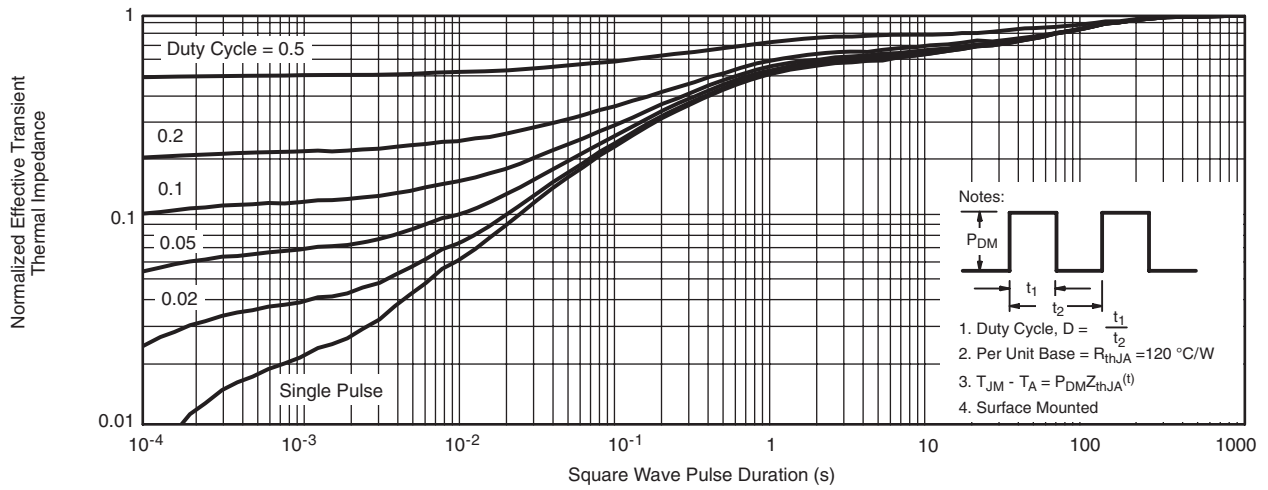
d Maximum junction temperature  $T_J=150^\circ\text{C}$ .

**Electronics Characteristics (Ta=25°C, unless otherwise noted)**

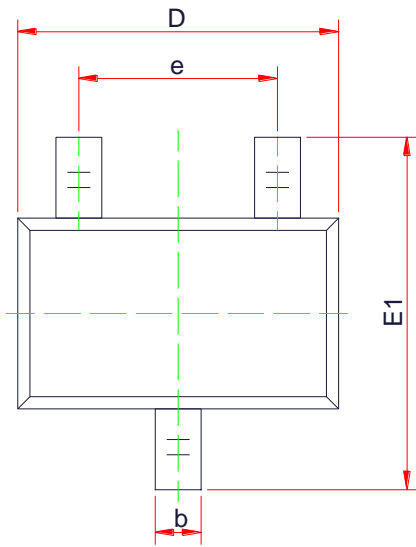
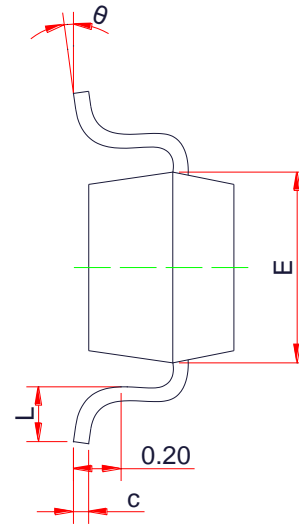
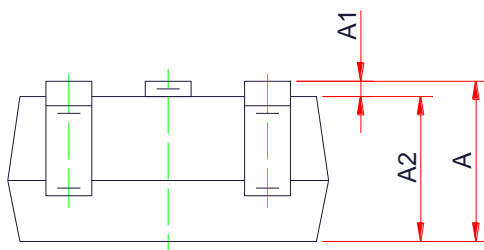
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-to-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0\text{ V}, I_D = -250\mu\text{A}$	-30			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -24\text{V}, V_{GS} = 0\text{V}$			-1	$\mu\text{A}$
Gate-to-source Leakage Current	$I_{GSS}$	$V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{V}$			$\pm 100$	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_D = -250\mu\text{A}$	-1.5	-1.9	-2.5	V
Drain-to-source On-resistance <sup>b, c</sup>	$R_{DS(on)}$	$V_{GS} = -10\text{V}, I_D = -3.1\text{A}$		58	68	m $\Omega$
		$V_{GS} = -4.5\text{V}, I_D = -2.8\text{A}$		80	95	
Forward Transconductance	$g_{FS}$	$V_{DS} = -5\text{ V}, I_D = -5.0\text{A}$		8.2		s
<b>CAPACITANCES, CHARGES</b>						
Input Capacitance	$C_{ISS}$	$V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz},$ $V_{DS} = -20\text{V}$		654		pF
Output Capacitance	$C_{OSS}$			67		
Reverse Transfer Capacitance	$C_{RSS}$			56		
Total Gate Charge	$Q_{G(TOT)}$	$V_{GS} = -10\text{ V},$ $V_{DS} = -15\text{V},$ $I_D = -3.1\text{A}$		1.55		nC
Threshold Gate Charge	$Q_{G(TH)}$			2.03		
Gate-to-Source Charge	$Q_{GS}$			3.15		
Gate-to-Drain Charge	$Q_{GD}$			12.9		
<b>SWITCHING CHARACTERISTICS</b>						
Turn-On Delay Time	$t_d(ON)$	$V_{GS} = -10\text{ V},$ $V_{DS} = -15\text{ V},$ $R_L = 5\Omega,$ $R_G = 15\Omega$		9.6		ns
Rise Time	$t_r$			4.0		
Turn-Off Delay Time	$t_d(OFF)$			34.8		
Fall Time	$t_f$			7.2		
<b>BODY DIODE CHARACTERISTICS</b>						
Forward Voltage	$V_{SD}$	$V_{GS} = 0\text{ V}, I_S = -1.0\text{A}$		-0.8	-1.5	V

**Typical Characteristics (Ta=25°C, unless otherwise noted)**

**Output characteristics**

**Transfer characteristics**

**On-Resistance vs. Drain current**

**On-Resistance vs. Gate-to-Source voltage**

**On-Resistance vs. Junction temperature**

**Threshold voltage vs. Temperature**

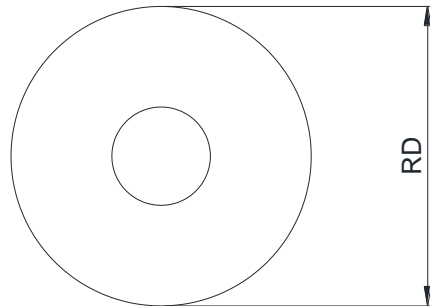
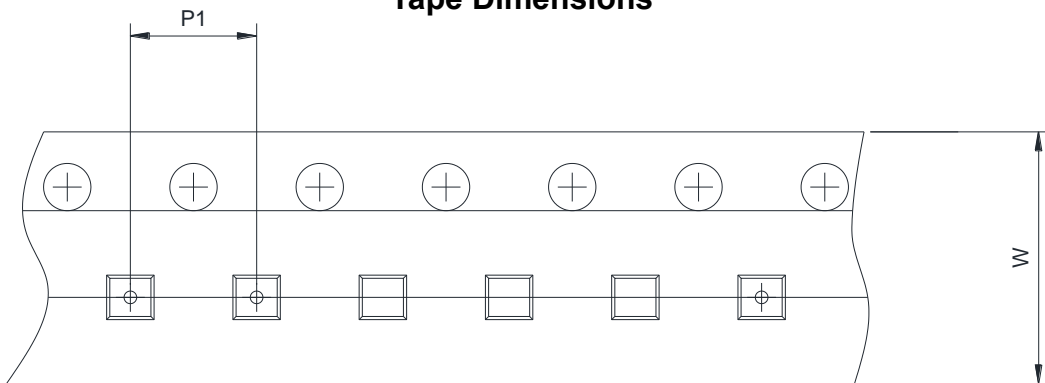
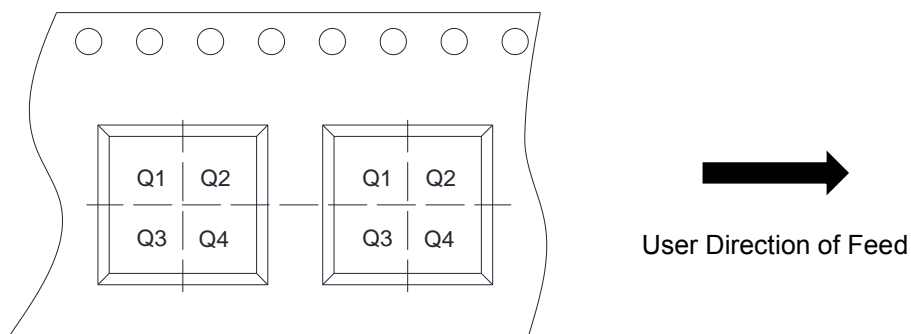

**Capacitance**

**Body diode forward voltage**

**Single pulse power**

**Safe operating power**

**Gate Charge Characteristics**



**Transient thermal response (Junction-to-Ambient)**

**PACKAGE OUTLINE DIMENSIONS**
**SOT-323**

**TOP VIEW**

**SIDE VIEW**

**SIDE VIEW**

Symbol	Dimensions in Millimeters		
	Min.	Typ.	Max.
A	0.80	0.95	1.10
A1	0.00	-	0.10
A2	0.80	0.90	1.00
b	0.20	0.30	0.40
c	0.05	0.10	0.15
D	1.90	2.05	2.20
E	1.15	1.25	1.25
E1	2.00	2.20	2.45
e	1.20	1.30	1.40
L	0.20	-	-
$\theta$	6° Ref		

**TAPE AND REEL INFORMATION**
**Reel Dimensions**

**Tape Dimensions**

**Quadrant Assignments For PIN1 Orientation In Tape**


RD	Reel Dimension	<input checked="" type="checkbox"/> 7inch	<input type="checkbox"/> 13inch
W	Overall width of the carrier tape	<input checked="" type="checkbox"/> 8mm	<input type="checkbox"/> 12mm <input type="checkbox"/> 16mm
P1	Pitch between successive cavity centers	<input type="checkbox"/> 2mm	<input checked="" type="checkbox"/> 4mm <input type="checkbox"/> 8mm
Pin1	Pin1 Quadrant	<input type="checkbox"/> Q1	<input type="checkbox"/> Q2 <input checked="" type="checkbox"/> Q3 <input type="checkbox"/> Q4



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